

Electronic Acknowledgement Receipt

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Application Number:	10791492
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Title of Invention:	Sealed three dimensional metal bonded integrated circuits
First Named Inventor:	Patrick Morrow
Customer Number:	59796
Filer:	Michael D. Plimier/Martha Peralez
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		P17817_AMENDNENT.pdf	92666	yes	10

	Multipart Description		
	Doc Desc	Start	End
	Amendment - After Non-Final Rejection	1	1
	Claims	2	6
	Applicant Arguments/Remarks Made in an Amendment	7	10
Warnings:			
Information:			
Total Files Size (in bytes):		92666	
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